

PATENT ASSIGNMENT COVER SHEET

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 Stylesheet Version v1.2

EPAS ID: PAT7249773

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIANCHOU (JACKSON) CHEN	03/02/2022
ZHIWEI (WILL) LIU	03/02/2022
BINGLIN (AARON) FENG	03/02/2022
YUQIANG (THOMAS) ZHAO	03/02/2022
WEI YAO	03/02/2022
RECEIVING PARTY DATA	
Name:	TYCO ELECTRONICS (SHANGHAI) CO. LTD.
Street Address:	UNIT 5 AND 6, LEVEL 2, BUILDING 20
Internal Address:	NO. 999 YINGLUN ROAD, CHINA (SHANGHAI) PILOT FREE TRADE ZONE
City:	SHANGHAI
State/Country:	CHINA
Postal Code:	200131
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17704594
CORRESPONDENCE DATA	
Fax Number:	(610)889-3696
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	610-889-3699
Email:	berwynipdocket@barley.com
Correspondent Name:	BARLEY SNYDER
Address Line 1:	2 GREAT VALLEY PARKWAY
Address Line 2:	SUITE 110
Address Line 4:	MALVERN, PENNSYLVANIA 19355
ATTORNEY DOCKET NUMBER:	21334-3472
NAME OF SUBMITTER:	SALVATORE ANASTASI
SIGNATURE:	/Salvatore Anastasi/
DATE SIGNED:	03/29/2022

Total Attachments: 3

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COMBINED DECLARATION AND ASSIGNMENT

As a below named and signing inventor, I hereby declare that:
this declaration is directed to inventions and improvements disclosed in:

- ☒ the attached application, or
☐ United States application or PCT international application number _____ filed on _____,
entitled Flag Shape Contact ("the APPLICATION");

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

As a below named and signing inventor, acknowledging that I have assigned or have obligations to assign the APPLICATION to:

Tyco Electronics (Shanghai) Co., Ltd. ("ASSIGNEE"), a corporation organized and existing under and by virtue of the laws of China, having its principal place of business at Unit 5 and 6, Level 2, Building 20, No. 999 Yinglun Road, Pilot Free Trade Zone, Shanghai, China 200131

for a valuable consideration, the receipt of which is hereby acknowledged, I do hereby sell, assign, transfer, and set over unto the said ASSIGNEE, its successors and assigns, my full and entire right, title and interest in and to the APPLICATION, the inventions and improvements disclosed in the APPLICATION, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent to be granted and issued therefor, not only for, to and in the United States of America, its territories and possessions, but also for, to and in all other countries, including all priority rights under the International Convention, and all reissues, re-examinations, renewals or extensions thereof; and I hereby authorize and request the United States Patent and Trademark Office and/or other patent office(s) to issue said Letters Patent to said ASSIGNEE, its successors and assigns, in accordance with this assignment.

Legal Name	Signature	Date
Jianchou (Jackson) CHEN	JACKSON C	2022-03-02
YuQiang (Thomas) ZHAO		
Wei YAO		
Zhiwei (Will) LIU	Willie Liu	2022.3.2
Binglin (Aaron) FENG	Aaron Feng	2022.3.2

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Legal Name	Signature	Date
Jianchou (Jackson) CHEN		
YuQiang (Thomas) ZHAO	<i>Thomas Zhao</i>	3/2 '22
Wei YAO		
Zhiwei (Will) LIU		
Binglin (Aaron) FENG		

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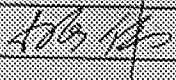
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